

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT3989151

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
XIAO "CHARLES" YANG	11/02/2010
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	MCUBE, INC.
<b>Street Address:</b>	2750 SAND HILL ROAD
<b>City:</b>	MENLO PARK
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	94025
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	14445012
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Email:</b>	jhwang@kilpatricktownsend.com
<b>Correspondent Name:</b>	JASMINE HWANG
<b>Address Line 1:</b>	TWO EMBARCADERO CENTER
<b>Address Line 2:</b>	SUITE 1900
<b>Address Line 4:</b>	SAN FRANCISCO, CALIFORNIA 94111
<b>ATTORNEY DOCKET NUMBER:</b>	92580-002820US-914832
<b>NAME OF SUBMITTER:</b>	DAH-BIN KAO
<b>SIGNATURE:</b>	/Dah-Bin Kao/
<b>DATE SIGNED:</b>	08/02/2016
<b>Total Attachments: 1</b>	
source=Assignment_092580_002810US#page1.tif	

**ASSIGNMENT OF PATENT APPLICATION**

SOLE

WHEREAS, the below-listed individual, herein referred to as "Assignor," is the inventor of the invention described and set forth in the following application for United States Letters Patent:

**System on a Chip Using Integrated MEMS and CMOS Devices**

Filed October 27, 2010, as U.S. Application No. 12/913,440

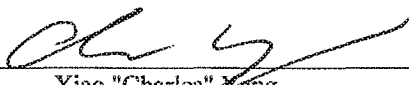
WHEREAS, MCube Inc., located at 2750 Sand Hill Road, Menlo Park, CA 94025, hereinafter referred to as "Assignee," is desirous of acquiring an interest in the invention and application and in any U.S. Letters Patent and Registrations which may be granted on the same;

For good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has assigned, and by these presents does assign to Assignee all right, title and interest in and to the invention and application and to all foreign counterparts (including patent, utility model and industrial designs), and in and to any Letters Patent and Registrations which may hereafter be granted on any patent application claiming priority from the same in the United States and all countries throughout the world, and to claim the priority from the application as provided by the Paris Convention. The right, title and interest is to be held and enjoyed by Assignee and Assignee's successors and assigns as fully and exclusively as it would have been held and enjoyed by Assignor had this Assignment not been made, for the full term of any Letters Patent and Registrations which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees that Assignor will, without charge to Assignor, but at Assignee's expense, (a) cooperate with Assignee in the prosecution of U.S. Patent applications and foreign counterparts on the invention and any improvements, (b) execute, verify, acknowledge and deliver all such further papers, including applications and instruments of transfer, and (c) perform such other acts as Assignee lawfully may request to obtain or maintain Letters Patent and Registrations for the invention and improvements in any and all countries, and to vest title thereto in Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has signed his/her name on the date indicated.

Dated: 11/2/10

  
\_\_\_\_\_  
Xiao "Charles" Yang

62965750 v1